

Low Dropout Linear Regulator Controller

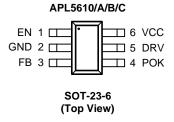
Features

- Wide Supply Voltage Range from 4.5 to 13.5V
- High Output Accuracy Over Operating Temperature and Loading Ranges
- · Fast Transient Response
- Power-On-Reset Monitoring on VCC
- Internal Soft-Start Function
- Low Shutdown Current: < 5mA
- Enable Control Function
- Under-Voltage Protection
- · Power-OK Output with a Delay Time
- Four Versions of IC Available:
 - APL5610: $V_{\rm REF}$ =0.8V, UVP Activated after $V_{\rm out}$ is Ready
 - APL5610A: V_{REF} =0.8V, UVP Activated after V_{cc} is Supplied
 - APL5610B: V_{REF} =0.5V, UVP Activated after V_{out} is Readv
 - APL5610C: V_{REF} =0.5V, UVP Activated after V_{cc} is Supplied
- SOT-23-6 Package
- Lead Free and Green Devices Available (RoHS Compliant)

Applications

- Note Book PC Applications
- Motherboard Applications

Pin Configuration



General Description

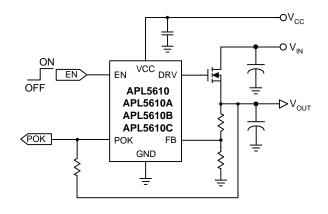
The APL5610 serise is a low dropout linear regulator controller.

The APL5610 serise could drive an external N-Channel MOSFET and provides an adjustable output by using an external resistive divider.

The APL5610 serise integrates various functions. For example, a Power-On-Reset (POR) circuit monitors VCC supply voltage to prevent wrong operations; the function of Under-Voltage Protection (UVP) protects the device from short circuit condition. A POK indicates that the output status with time delay which is set internally. It can control other converter for power sequence. Moreover, the APL5610 serise can be enabled by other power system; namely, holding the EN above 1.6V enables output and pulling the EN under 0.4 disables output.

The APL5610 serise is available in a SOT-23-6 package.

Simplified Application Circuit



ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.



Ordering and Marking Information

| APL5610 APL5610A APL5610B APL5610C | Assembly Material Handling Code Temperature Range Package Code | Package Code C: SOT-23-6 Operating Ambient Temperature Range I: -40 to 85 °C Handling Code TR: Tape & Reel Assembly Material G: Halogen and Lead Free Device |
|---|--|--|
| APL5610 C: | L10X | X - Date Code |
| APL5610A C: | LA0X | X - Date Code |
| APL5610B C: | LB0X | X - Date Code |
| APL5610C C: | LC0X | X - Date Code |

Note: ANPEC lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. ANPEC lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. ANPEC defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

Absolute Maximum Ratings (Note 1)

| Symbol | Parameter | Rating | Unit |
|------------------|--|------------------------------|------|
| V _{cc} | VCC Input Voltage (VCC to GND) | -0.3 to 15 | V |
| | EN, POK, to GND Voltage | -0.3 to 7 | V |
| V_{FB} | FB to GND Voltage | -0.3 to 7 | V |
| V_{DRV} | DRV to GND Voltage | -0.3 to V _{CC} +0.3 | V |
| TJ | Maximum Junction Temperature | 150 | °C |
| T _{STG} | Storage Temperature | -65 to 150 | °C |
| T_{SDR} | Maximum Lead Soldering Temperature, 10 Seconds | 260 | °C |

Note1: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability

Thermal Characteristic

| Symbol | Parameter | Typical Value | Unit |
|---------------|--|---------------|------|
| θ_{JA} | Junction-to-Ambient Resistance in Free Air (Note 2) SOT-23-6 | 250 | °C/W |

Note 2: θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air.



Recommended Operating Conditions (Note 3)

| Symbol | Parameter | Range | Unit |
|------------------|--------------------------------|---|------|
| V _{CC} | VCC Input Voltage (VCC to GND) | 4.5 to 13.5 | V |
| V _{EN} | EN to GND Voltage | 0 to 5.5 | V |
| V _{OUT} | VOUT Output Voltage (Note4) | 0.8/0.5 ~ V _{IN} - V _{DROP} | V |
| T _A | Ambient Temperature | -40 to 85 | °C |
| TJ | Junction Temperature | -40 to 125 | °C |

Note 3: Refer to the typical application circuit.

Electrical Characteristics

Unless otherwise specified, these specifications apply over V_{CC} = 5/12V, T_A = -40 to 85 °C. Typical values are at T_A =25°C.

| Symbol | Parameter | Test Conditions | | APL5610/A/B/C | | | Unit |
|-------------------------|------------------------------|---|---|---------------|------|------|-------|
| Symbol | Farameter | | | Min. | Тур. | Max. | Ullit |
| SUPPL | Y CURRENT | • | | | • | • | |
| | VCC Cumply Current | V _{CC} = 12V | | - | 0.8 | 1.0 | A |
| I _{CC} | VCC Supply Current | $V_{CC} = 5V$ | | - | 0.8 | 1.0 | - mA |
| | VCC Shutdown Current | V _{CC} = 12V, EN=GND | | - | - | 5 | |
| I _{SD} | VCC Shutdown Current | V _{CC} = 5V, EN=GND | | - | - | 5 | μΑ |
| POWER | R-ON-RESET (POR) | | | • | | | |
| | VCC POR Threshold | V _{CC} rising | | 3.8 | 4.0 | 4.2 | V |
| | VCC POR Hysteresis | | | - | 0.4 | - | V |
| REFERI | ENCE VOLTAGE | • | | | • | • | |
| | Defenses Veltane | V _{CC} = 12V. T ₄ = 25 °C | APL5610/A | - | 0.8 | - | V |
| V_{REF} | Reference Voltage | V _{CC} = 12 V, 1 _A = 25 C | APL5610B/C | - | 0.5 | - | V |
| | Reference Voltage Accuracy | V _{CC} = 12V, T _A = 25 °C | | -0.5 | - | 0.5 | % |
| | Line Regulation | V _{CC} = 4.5V to 13.2V | | -1.5 | - | 1.5 | % |
| | FB Input Current | | | -100 | - | 100 | nA |
| ERROR | AMPLIFIER | | | ļ | | | |
| | Unity Gain Bandwidth | V _{CC} = 5/12V | | - | 2 | - | MHz |
| | Open Loop DC Gain | V _{CC} =12V, No Load | | 60 | 80 | - | dB |
| PSRR | Power Supply Rejection Ratio | V _{CC} =12V, 100Hz, No L | .oad | 50 | - | - | dB |
| \/ | DDV/ High Voltage | $V_{CC} = 12V$, $I_{DRV (SOURCE)} = 5mA$, $V_{FB} = 0.6V$ | | 11.2 | 11.5 | - | V |
| V _{DRV (high)} | DRV High Voltage | $V_{CC} = 5V$, $I_{DRV (SOURCE)} = 5mA$, $V_{FB} = 0.6V$ | | - | 4.7 | - | , v |
| \/ | DRV Low Voltage | $V_{CC} = 12V$, $I_{DRV (SINK)} = 5r$ | $V_{CC} = 12V$, $I_{DRV (SINK)} = 5mA$, $V_{FB} = 1V$ | | 0.5 | 1 | V |
| $V_{DRV (low)}$ | DRV Low Vollage | V_{CC} =5V, $I_{DRV (SINK)}$ = 5mA, V_{FB} = 1V | | - | 0.8 | - | V |
| | DRV Source Current | V _{CC} =12V, V _{DRV} =6V, V _F | _B = 0.6V | - | 50 | - | A |
| DRV (source) | DRV Source Current | V _{CC} =5V, V _{DRV} =2.5V, V | _{FB} = 0.6V | - | 10 | - | mA |
| | DRV Sink Current | V _{CC} =12V, V _{DRV} =6V, V _F | _B = 1V | - | 40 | - | mΛ |
| I _{DRV (sink)} | DRV SIIK CUITEIIL | $V_{CC} = 5V, V_{DRV} = 2.5V, V$ | _{FB} = 1V | - | 10 | - | mA |

Note 4: V_{DROP} defined as the V_{IN} - V_{OUT} voltage at V_{OUT} = 98% normal V_{OUT} . The linear regulator must provide the output MOSFET with sufficient Gate-to-Source voltage ($V_{GS} = V_{CC} - V_{OUT}$) to regulate the output voltage.



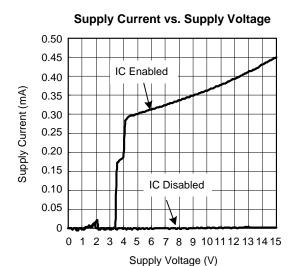
Electrical Characteristics (Cont.)

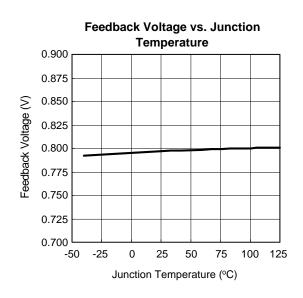
Unless otherwise specified, these specifications apply over V_{CC} = 5/12V, T_A = -40 to 85 $^{\circ}C$. Typical values are at T_A =25 $^{\circ}C$.

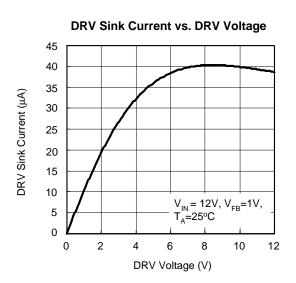
| Cumbal | Parameter | Test Conditions | AP | L5610/A/I | B/C | Unit |
|-----------------------|---------------------------------|--|------|-----------|------|-------|
| Symbol | Farameter | rest conditions | Min. | Тур. | Max. | Offic |
| ENABL | E | | | | | |
| V _{EN (TH)} | EN Logic High Threshold Voltage | V _{EN} rising | 1 | 0.8 | - | V |
| | EN Hysteresis | | - | 50 | - | mV |
| | EN Shutdown Debounce | V _{EN} falling | - | 2 | - | μs |
| SOFT-ST | ART | | | | | |
| T _{ss} | Soft-Start Interval | | 100 | 200 | 300 | μs |
| UNDER | -VOLTAGE PROTECTION (UVP) | | | | | |
| V _{UV (TH)} | Under-Voltage Threshold | V _{EN} =5V, V _{FB} falling | 68 | 75 | 82 | % |
| | UVP Debounce Interval | | - | 5 | - | μs |
| POWER | R-OK AND DELAY | | | | | |
| V _{POK (TH)} | Rising POK Threshold Voltage | V _{CC} =12V, V _{FB} rising | - | 90 | - | % |
| | POK Threshold Hysteresis | V _{CC} =12V | - | 15 | - | % |
| | POK Pull-Low Voltage | V _{CC} =12V, POK sinks 4mA | - | 0.2 | 0.4 | V |
| | POK Debounce Interval | V _{FB} <falling pok="" td="" threshold<="" voltage=""><td>-</td><td>5</td><td>-</td><td>μs</td></falling> | - | 5 | - | μs |
| POWER | R-OK AND DELAY (CONT.) | • | | • | | |
| | POK Delay Time | From V _{FB} =V _{THPOK} to rising edge of the V _{POK} | 1 | 2 | 4 | ms |
| | POK Leakage Current | V _{POK} =5V | 1 | - | 1.0 | μΑ |

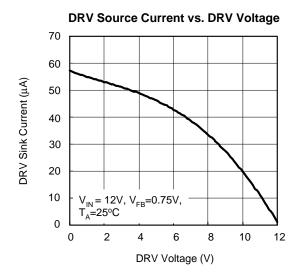


Typical Operating Characteristics







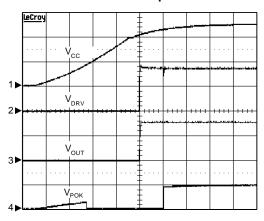




Operating Waveforms

The test condition $T_A = 25$ °C unless otherwise specified.

Turn On Response

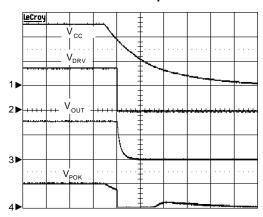


 $\mathsf{V}_\mathsf{CC} \text{=-}5\mathsf{V},\, \mathsf{V}_\mathsf{IN} \text{=-}5\mathsf{V},\, \mathsf{V}_\mathsf{OUT} \text{=-}1.5\mathsf{V},\, \mathsf{C}_\mathsf{IN} \text{=-}33\mu\textrm{F}/$

 $Electrolytic, C_{OUT} \!=\! 1 \mu F/Electrolytic,$

 $\begin{array}{l} {\rm CH1: V_{CC}, \, 2V/Div, \, DC} \\ {\rm CH2: V_{DRV}, \, \, 2V/Div, \, DC} \\ {\rm CH3: V_{OUT}, \, \, 1V/Div, \, DC} \\ {\rm CH4: V_{POK}, \, \, 5V/Div, \, DC} \\ {\rm TIME: \, 2ms/Div} \end{array}$

Turn Off Response

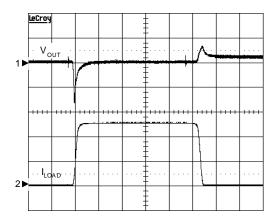


 V_{CC} =5V, V_{IN} =5V, V_{OUT} =1.5V, C_{IN} =33 μ F/

Electrolytic, C_{OUT} = 1μF/Electrolytic,

 $\begin{array}{l} \text{CH1: V}_{\text{CC}}, 2\text{V/Div, DC} \\ \text{CH2: V}_{\text{DRV}}, 2\text{V/Div, DC} \\ \text{CH3: V}_{\text{OUT}}, 1\text{V/Div, DC} \\ \text{CH4: V}_{\text{POK}}, 5\text{V/Div, DC} \\ \text{TIME: 0.1s/Div} \end{array}$

Load Transient Response-1



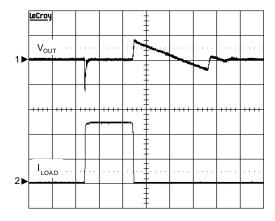
 $V_{CC} = 5V, V_{IN} = 5V, V_{OUT} = 1.2V,$

 I_{LOAD} =0-5-0A(rising/falling edge=1A/ μ s),

 C_{IN} =22 μ F/MLCC, C_{OUT} =100 μ F/Electrolytic,

CH1: V_{OUT} , 50mV/Div, AC CH2: I_{OUT} , 2A/Div, DC TIME:20 μ s/Div

Load Transient Response-2



 $V_{CC} = 5V, V_{IN} = 5V, V_{OUT} = 1.5V,$

 I_{LOAD} =0-5-0A(rising/falling edge=1A/ μs),

 $C_{\text{IN}}\!=\!\!22\mu\text{F/MLCC},\,C_{\text{OUT}}\!=\!\!22\mu\text{F/MLCC},$

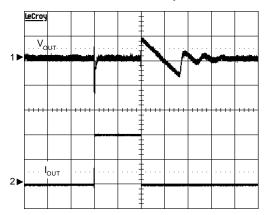
CH1: V_{OUT} , 50mV/Div, AC CH2: I_{OUT} , 2A/Div, DC TIME:100 μ s/Div



Operating Waveforms (Cont.)

The test condition $T_A = 25$ °C unless otherwise specified.

Load Transient Response-3



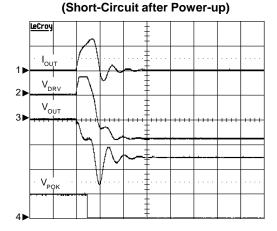
 $V_{CC} = 5V, V_{IN} = 5V, V_{OUT} = 1.5V,$

 I_{LOAD} =0-0.2-0A(rising/falling edge=1A/ μ s),

 $C_{\text{IN}}\!=\!\!22\mu\text{F/MLCC},\,C_{\text{OUT}}\!=\!\!22\mu\text{F/MLCC},$

CH1: V_{OUT}, 20mV/Div, AC CH2: I_{OUT}, 100mA/Div, DC

TIME:100µs/Div



Short Circuit Response

 $V_{CC} = 5V, V_{IN} = 5V, V_{OUT} = 1.5V,$

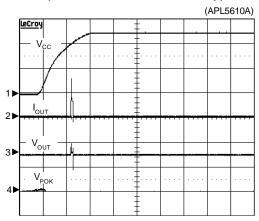
 C_{IN} =22 μ F/MLCC, C_{OUT} =22 μ F/MLCC, CH1: I_{OUT} , 20A/Div, DC

 $\mathsf{CH2} \ldotp \mathsf{V}_{\mathsf{DRV}}, \, \mathsf{2V/Div}, \, \mathsf{DC}$

CH3: V_{OUT} (Short to GND after power-up),1V/Div, DC

CH4: V_{POK}, 5V/Div, DC TIME: 20µs/Div

Short Circuit Response (Short-Circuit before Power-up)



 $\mathsf{V}_\mathsf{CC} \texttt{=} \mathsf{5V}, \, \mathsf{V}_\mathsf{IN} \texttt{=} \mathsf{5V}, \, \mathsf{V}_\mathsf{OUT} \texttt{=} \mathsf{1.5V},$

 $C_{IN} = 22\mu F/MLCC, C_{OUT} = 22\mu F/MLCC,$

CH1: V_{CC}, 2V/Div, DC CH2: I_{OUT}, 20A/Div, DC

CH3: V_{OUT} (Short to GND before power-up),1V/Div, DC

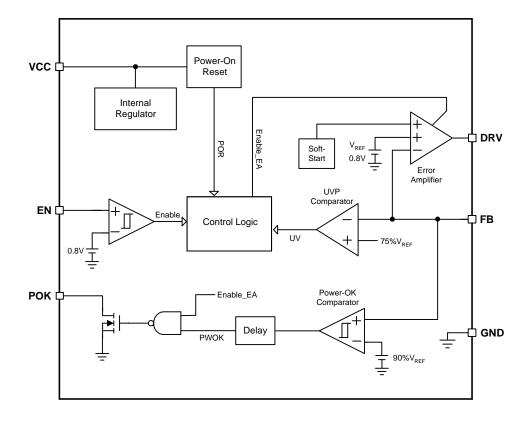
CH4: V_{POK}, 5V/Div, DC TIME: 20µs/Div



Pin Description

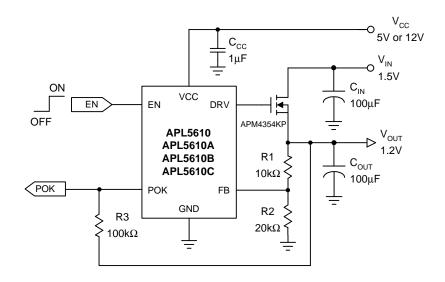
| Р | IN | FUNCTION | |
|-----|------|---|--|
| NO. | NAME | FUNCTION | |
| 1 | EN | Enable control pin. Pulling the EN high (VEN>1.6) enables the Vouт; forcing the EN low (VEN<0.4V) disables the Vouт. When re-enabled, the IC undergoes a new soft-start process. | |
| 2 | GND | Ground pin of the circuitry. All voltage levels are measured with respect to this pin. | |
| 3 | FB | Voltage Feedback Pin. Connecting this pin to an external resistor divider receives the feedback voltage of the regulator. | |
| 4 | POK | Power-OK signal output pin. This pin is an open-drain output used to indicate the status of output voltage by sensing FB voltage. This pin is pulled low when output voltage is not within the Power-OK voltage window. | |
| 5 | DRV | This pin drives the gate of an external N-channel MOSFET for linear regulator. | |
| 6 | VCC | Power input pin of the device. The voltage at this pin is monitored for Power-On-Reset purpose. | |

Block Diagram





Typical Application Circuit





Function Description

Power-On-Reset (POR)

The APL5610 series monitors the VCC pin voltage ($V_{\rm CC}$) for power-on-reset function to prevent wrong operation. The built-in POR circuit keeps the output shutting off until internal circuit is operating properly. Typical POR threshold is 4.0V with 0.4V hysteresis.

Soft-Start

The APL5610 series provides an internal soft-start circuitry to control rise rate of the output voltage and limit the current surge during start-up. Typical soft-start interval is about 0.3ms.

Under-Voltage Protection (UVP)

The APL5610 series monitors the voltage on FB. When the voltage on FB falls below the under-voltage threshold, the UVP circuit shuts off the output voltage immediately by pulling down DRV to 0V and latches APL5610 series off, requiring either a $V_{\rm CC}$ POR or EN re-enable again to restart.

The UVP activation timing is different in these 4 variants of IC, the APL5610,APL5610A, APL5610B, APL5610C. The APL5610 and APL5610B UVP is activated after $V_{\rm OUT}$ voltage has reached 90% POK threshold while the APL5610A and APL5610C UVP is activated after $V_{\rm CC}$ has been applied to VCC pin. In order to avoid erroneous UVP latchoff in APL5610A and APL5610C, please make sure the power sequence is a proper one when you use the APL5610A and APL5610C. For the suggested power sequence of APL5610A and APL5610C, you can refer to the Power Sequencing in Application Information.

Enable Control

The APL5610 series has a dedicated enable pin (EN). A logic low signal applied to this pin shuts down the output. Following a shutdown, a logic high signal re-enables the output through initiation of a new soft-start cycle. It's not necessary to use an external transistor to save cost.

Power-OK and Delay

The APL5610 series indicates the status of the output voltage by monitoring the feedback voltage (V_{FB}) on FB pin. As the V_{FB} rises and reaches the rising Power-OK voltage threshold (V_{POKTH}), an internal delay function starts to work. At the end of the delay time, the IC turns off the internal NMOS of the POK to indicate that the output is ok. As the V_{FB} falls and reaches the falling Power-OK voltage threshold, the IC turns on the NMOS of the POK (after a debounce time of 5µs typical).

Output Voltage Regulation

The APL5610 series is a linear regulator controller. An external N-channel MOSFET should be connected to DRV as the pass element. The output voltage set by the resistor divider is determined by:

$$V_{OUT} = 0.8x \left(1 + \frac{R1}{R2}\right) \qquad \text{for APL5610A}$$

$$V_{OUT} = 0.5x \left(1 + \frac{R1}{R2}\right) \qquad \text{for APL5610B, APL5610C}$$

Where R1 is connected from VOUT to FB and R2 is connected from FB to GND.



Application Information

Input Capacitor

The APL5610 series requires proper input capacitor of V_{IN} (connected to the external MOSFET's drain) to supply surge current during stepping load transients to prevent the input rail from dropping. Because the parasitic inductor from the voltage sources or other bulk capacitors to the V_{IN} limits the slew rate of the surge current, it is necessary to place the input capacitor near the MOSFET's drain as close as possible. If the MOSFET is located near the bulk capacitor for upstream voltage regulator, this input capacitor may not be required. The Input capacitor for V_{IN} should be larger than 1μF. Higher capacitance of this V_{IN} input capacitor is needed if the stepping load transients are large and fast.

Another input capacitor for V_{cc} is recommended. Placing the input capacitor of $V_{\rm cc}$ as close to VCC pin as possible prevents outside noise from entering APL5610's control circuitry. The recommended capacitance of VCC input capacitor is 1µF.

Output Capacitor

The APL5610 series needs a proper output capacitor to maintain circuit stability and to improve transient response over temperature and current. In order to insure the circuit stability, the proper output capacitor value should be larger than 10μF. With X5R and X7R dielectrics, 22μF is sufficient at all operating temperatures.

POK Pull High

The POK is an open-drain output that needs to be pulled high to a proper voltage (not greater than 5.5V) via a pullup resistor. The pull-up resistor can be $20k\Omega \sim 100k\Omega$.

MOSFET Selection

APL5610 series requires an N-channel MOSFET as a pass element. There are some parameters must be considered in selecting a MOFSET, including: Threshold Voltage V_{TH} , $R_{DS(on)}$, Continuous I_{DS} current and Package Thermal Resistance. The MOSFET selection guidelines are

1. Threshold Voltage V_{TH} : Select the MOSFET V_{TH} rating to meet the following equation:

$$V_{TH} < V_{CC(min)} - V_{OUT(max)}$$

2. $R_{DS(on)}$: Select the MOSFET $R_{DS(on)}$ to ensure that the output voltage will never enter dropout:

$$R_{DS(on)(max)} < (V_{IN(min)} - V_{OUT(max)}) / I_{OUT(max)}$$
 (Note: $R_{DS(on)(max)}$ must be met at all temperatures and at the minimum V_{GS} condition)

3. Continuous $I_{DS(max)}$: Select the $I_{DS(max)}$ that can support the output current:

Continuous $I_{DS(max)} > I_{OUT(max)}$

4. Package Thermal Resistance $\theta_{\text{(IA)}}$: Select a package of MOSFET that can dissipate the heat, $\theta_{\text{\tiny (JA)}}$ < $(\text{T}_{\text{\tiny J}}$ - $\text{T}_{\text{\tiny A}})/\text{P}_{\text{\tiny D}}$, where T_i is the maximum allowable Junction temperature of MOSFET, $T_{_{\rm A}}$ is the ambient temperature, $P_{_{\rm D}}$ is the maximum power dissipation on MOSFET, calculated as

$$P_{D} = (V_{IN(max)} - V_{OUT(min)}) \times I_{OUT(max)}$$

Power Sequencing (Only for APL5610A and APL5610C)

At start-up, it is necessary to ensure that the $V_{\scriptscriptstyle IN}$ (the voltage supplied to MOSFET drain), V_{cc} and V_{en} are sequenced correctly to avoid erroneous latch-off. To avoid UVP latch-off happened at start-up due to sequencing issues, the key method is the V_{IN} should be larger than the output under-voltage threshold plus the drop through the pass MOSFET when that output is enabled.

Figure 1 and 2 show the two types of power on sequence. Figure 1 shows the V_{CC} comes up before the V_{IN} , and then the output would be enabled when the $V_{\scriptscriptstyle{\sf FN}}$ is applied. Figure 2 shows the V_{IN} comes up before the V_{CC} , and then the output can either be enabled with the V_{CC} or V_{EN} . Recommended power on sequence is shown in Figure1 and

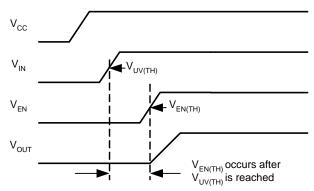


Figure 1. APL5610A/C supply comes up before MOSFET drain supply



Application Information (Cont.)

Power Sequencing (Only for APL5610A and APL5610C) (Cont.)

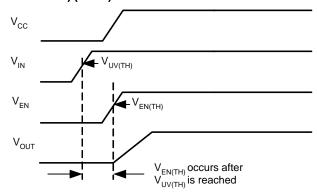


Figure 2. MOSFET drain supply comes up before APL5610A/C supply

Short-Circuit Concerns (Only for APL5610 and APL5610B)

Since the APL5610 and APL5610B UVP function is activated after the V_{OUT} reaches 90% level, any combinations of sequence among V_{IN} , V_{CC} , and V_{EN} are allowable. However, please note that the advantage of none-power-sequencing brings a drawback. If and only if a short-circuit condition of output voltage occurs before V_{IN} supply, the UVP won't be activated. Thus, the short-circuit current persists to flow and could impair the MOSFET. If in your application the short-circuit is most likely to be encountered before V_{IN} supply, we suggest you use the APL5610A or APL5610C instead of the APL5610 or APL5610B, who can provide this short-circuit protection. Nevertheless, if the V_{IN} supply can provide the OCP protection, this short-circuit won't be an issue in APL5610.

Layout Consideration

Figure 3 illustrates the layout. Below is a checklist for your layout:

- 1. Please place the input capacitor \mathbf{C}_{VCC} close to the VCC pin.
- 2. Please place the C_{VIN} close to the MOSFET's drain.
- 3. Layout a copper plane for N-channel MOSFET's drain to improve the heat dissipation.
- 4. Output capacitor C_{OUT} for load must be placed near the load as close as possible..

5. Large current paths, the bold lines in figure 3, must have wide tracks.

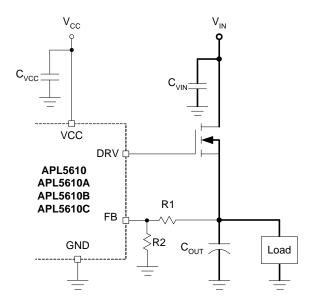
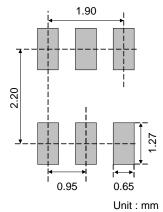


Figure 3



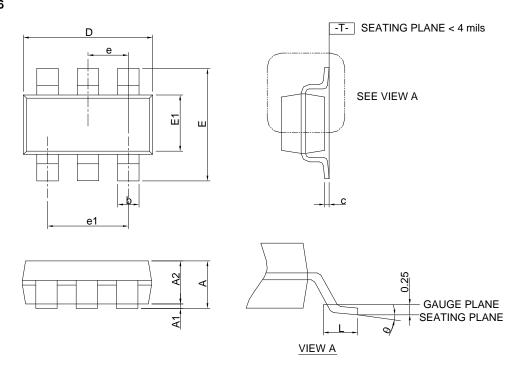
SOT-23-6

Figure 4. Recommended Minimum Footprint



Package Information

SOT-23-6



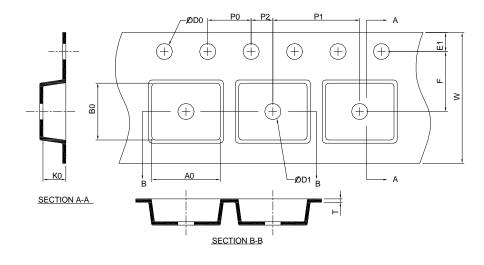
| Ş | SOT-23-6 | | | | | |
|--------|----------|-------|-------|-------|--|--|
| SYMBOL | MILLIM | ETERS | INC | HES | | |
| 6 | MIN. | MAX. | MIN. | MAX. | | |
| Α | | 1.45 | | 0.057 | | |
| A1 | 0.00 | 0.15 | 0.000 | 0.006 | | |
| A2 | 0.90 | 1.30 | 0.035 | 0.051 | | |
| b | 0.30 | 0.50 | 0.012 | 0.020 | | |
| С | 0.08 | 0.22 | 0.003 | 0.009 | | |
| D | 2.70 | 3.10 | 0.106 | 0.122 | | |
| Е | 2.60 | 3.00 | 0.102 | 0.118 | | |
| E1 | 1.40 | 1.80 | 0.055 | 0.071 | | |
| е | 0.95 BSC | | 0.03 | 7 BSC | | |
| e1 | 1.90 BSC | | 0.07 | 5 BSC | | |
| L | 0.30 | 0.60 | 0.012 | 0.024 | | |
| θ | 0° | 8° | 0° | 8° | | |

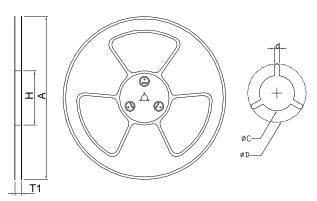
Note: 1. Follow JEDEC TO-178 AB.

Dimension D and E1 do not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 10 mil per side.



Carrier Tape & Reel Dimensions





| Application | Α | Н | T1 | С | d | D | W | E1 | F |
|-------------|-------------|---------|-------------------|--------------------|----------|-----------|-----------|------------|-----------|
| | 178.0 ±2.00 | 50 MIN. | 8.4+2.00 -0.00 | 13.0+0.50 -0.20 | 1.5 MIN. | 20.2 MIN. | 8.0 ±0.30 | 1.75 ±0.10 | 3.5 ±0.05 |
| | | | | | | | | | |
| SOT-23-6 | P0 | P1 | P2 | D0 | D1 | Т | A0 | В0 | K0 |

(mm)

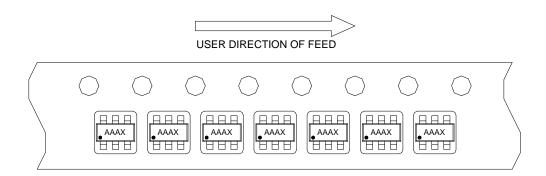
Devices Per Unit

| Package Type | Unit | Quantity |
|--------------|-------------|----------|
| SOT-23-6 | Tape & Reel | 3000 |

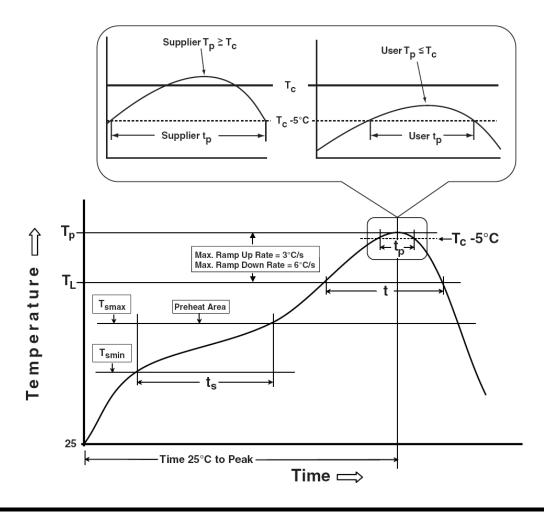


Taping Direction Information

SOT-23-6



Classification Profile





Classification Reflow Profiles

| Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|------------------------------------|---|
| 100 °C 150 °C 60-120 seconds | 150 °C 200 °C 60-120 seconds |
| 3 °C/second max. | 3°C/second max. |
| 183 °C 60-150 seconds | 217 °C 60-150 seconds |
| See Classification Temp in table 1 | See Classification Temp in table 2 |
| 20** seconds | 30** seconds |
| 6 °C/second max. | 6 °C/second max. |
| 6 minutes max. | 8 minutes max. |
| | 100 °C 150 °C 60-120 seconds 3 °C/second max. 183 °C 60-150 seconds See Classification Temp in table 1 20** seconds 6 °C/second max. |

^{*} Tolerance for peak profile Temperature (Tp) is defined as a supplier minimum and a user maximum.

Table 1. SnPb Eutectic Process – Classification Temperatures (Tc)

| Package Thickness | Volume mm ³ <350 | Volume mm³ ³350 |
|----------------------|--------------------------------|--------------------|
| <2.5 mm | 235 °C | 220 °C |
| ≥2.5 mm | 220 °C | 220 °C |

Table 2. Pb-free Process – Classification Temperatures (Tc)

| Package Thickness | Volume mm ³ <350 | Volume mm ³ 350-2000 | Volume mm ³ >2000 |
|----------------------|--------------------------------|------------------------------------|------------------------------|
| <1.6 mm | 260 °C | 260 °C | 260 °C |
| 1.6 mm – 2.5 mm | 260 °C | 250 °C | 245 °C |
| ≥2.5 mm | 250 °C | 245 °C | 245 °C |

Reliability Test Program

| Test item | Method | Description |
|---------------|--------------------|--|
| SOLDERABILITY | JESD-22, B102 | 5 Sec, 245°C |
| HOLT | JESD-22, A108 | 1000 Hrs, Bias @ T _j =125°C |
| PCT | JESD-22, A102 | 168 Hrs, 100%RH, 2atm, 121°C |
| тст | JESD-22, A104 | 500 Cycles, -65°C~150°C |
| НВМ | MIL-STD-883-3015.7 | VHBM 2KV |
| MM | JESD-22, A115 | VMM 200V |
| Latch-Up | JESD 78 | 10ms, 1 _{tr} 100mA |

^{**} Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.



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